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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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FDS86240 N-Channel Shielded Gate PowerTrench[®] MOSFET 150 V, 7.5 A, 19.8 m Ω

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 19.8 m Ω at V_{GS} = 10 V, I_D = 7.5 A
- Max $r_{DS(on)}$ = 26 m Ω at V_{GS} = 6 V, I_D = 6.4 A
- High Performance Trench Technology for Extremely Low r_{DS(on)}
- High Power and Current Handling Capability in a Widely Used Surface Mount Package
- 100% UIL Tested
- RoHS Compliant



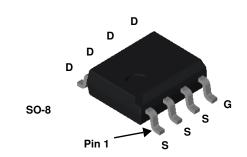
General Description

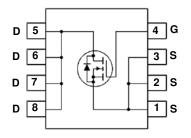
This N-Channel MOSFET is produced using ON Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

ON Semiconductor®

Applications

- DC/DC Converters and Off-Line UPS
- Distributed Power Architectures and VRMs
- Primary Switch for 24 V and 48 V Systems
- High Voltage Synchronous Rectifier





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units		
V _{DS}	Drain to Source Voltage			150	V		
V _{GS}	Gate to Source Voltage			±20	V		
ID	Drain Current -Continuous			7.5			
	-Pulsed		(Note 4)	199	Α		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	220	mJ		
P _D	Power Dissipation	T _C = 25 °C	(Note 1)	5.0	w		
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	vv		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C		

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	25	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	0/ 00

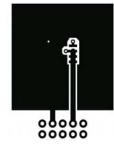
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS86240	FDS86240	SO-8	13 "	12 mm	2500 units

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	150			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		105		mV/°C	
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	2	2.7	4	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-11		mV/°C	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 7.5 A		17.3	19.8	mΩ	
		$V_{GS} = 6 V, I_D = 6.4 A$		19.7	26		
		V_{GS} = 10 V, I _D = 7.5 A, T _J = 125 °C		30.8	35.3	1	
9fs	Forward Transconductance	$V_{DS} = 10 \text{ V}, \ I_D = 7.5 \text{ A}$		26		S	
	Characteristics			1000	0570		
C _{iss}	Input Capacitance	– V _{DS} = 75 V, V _{GS} = 0 V,		1930	2570	pF	
C _{oss}	Output Capacitance	-f = 1 MHz		198	265	pF	
C _{rss}	Reverse Transfer Capacitance Gate Resistance			8.3	15	pF	
R _g				0.84		Ω	
	Characteristics					1	
t _{d(on)}	Turn-On Delay Time			14	26	ns	
t _r	Rise Time	$V_{DD} = 75 \text{ V}, \text{ I}_{D} = 7.5 \text{ A},$		4.2	10	ns	
t _{d(off)}	Turn-Off Delay Time Fall Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		24 4.9	39 10	ns	
$\frac{t_f}{O}$	Total Gate Charge	V _{GS} = 0 V to 10 V		4.9 28	40	ns nC	
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$ $V_{GS} = 0 V \text{ to } 5 V$ $V_{DD} = 75 V$,		16	40 22	nC	
Q _{g(TOT)} Q _{gs}	Gate to Source Charge	$V_{\rm GS} = 0.0100 \text{V}_{\rm DD} = 75 \text{V},$ $I_{\rm D} = 7.5 \text{A}$		7.6	~~~	nC	
Q _{gd}	Gate to Drain "Miller" Charge			5.3		nC	
	-			0.0			
Drain-Soເ	arce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 7.5 A$ (Note 2)		0.77	1.3	v	
• 50	_	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.70	1.2	v	
t _{rr}	Reverse Recovery Time	- I _F = 7.5 A, di/dt = 100 A/μs		75	120	ns	
Q _{rr}	Reverse Recovery Charge	$\mu_{\rm F} = 7.5 \Lambda, {\rm m/m} = 100 \Lambda/\mu_{\rm F}$		109	175	nC	

NOTES:

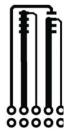
1. R_{0,1A} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0,1C} is guaranteed by design while R_{0CA} is determined by the user's board design.



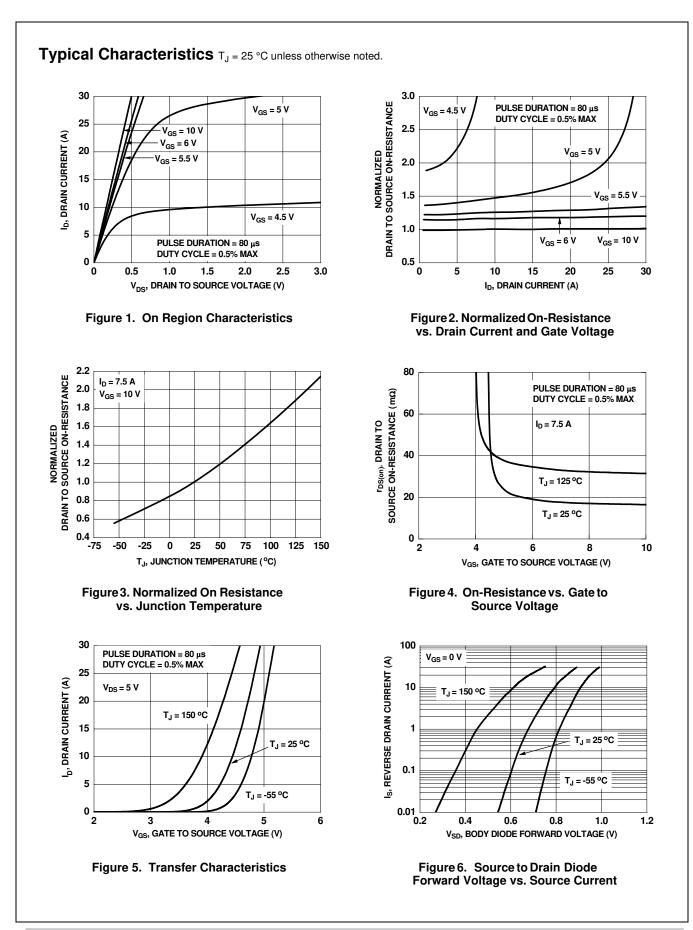
2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

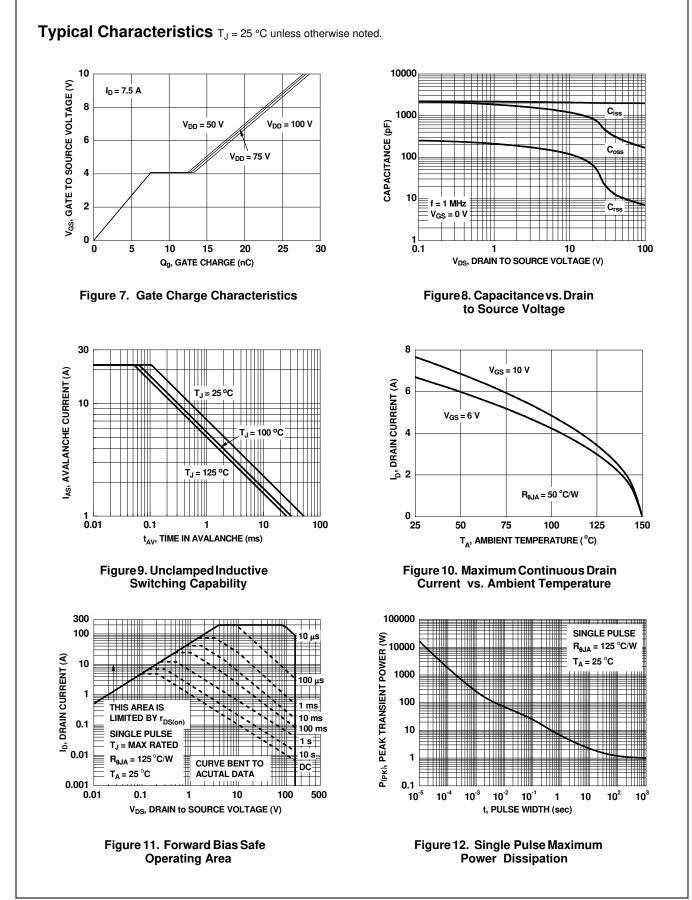
3. Starting T_J = 25 °C, L = 1 mH, I_{AS} = 21 Å, V_{DD} = 135 V, V_{GS} = 10 V. 4. Pulsed Id please refer to Fig 11 SOA graph for more details.

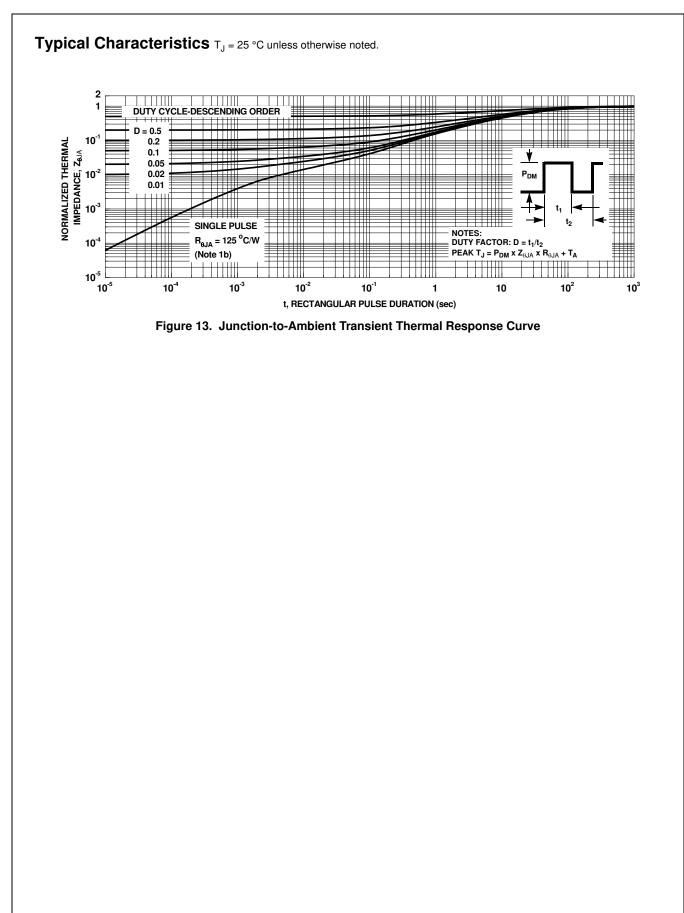
a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper.

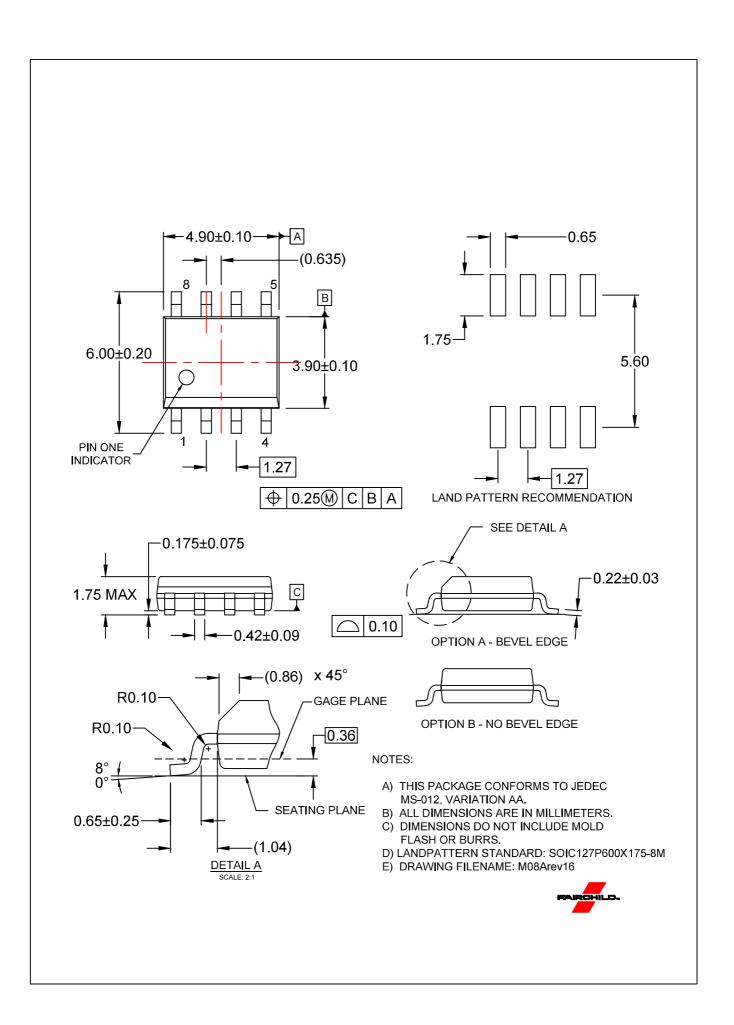


b) 125 °C/W when mounted on a minimum pad.









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